IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

plicant:

NOV 1 3 2007

Seonard Forbes et al.

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Docket No.:

1303.109US1

Serial No.: 10/623,788

Filed:

July 21, 2003

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Examiner:

Pamela E. Perkins

Group Art Unit: 2822

MS Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- X Return postcard.
- <u>X</u> Response Under 37 CFR 1.111 (20 pgs.).
- X Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (2 pgs.), and copies of 21 cited documents.
- X Authorization to charge Deposit Account 19-0743 in the amount of \$180.00 to cover the fee for consideration of Information Disclosure Statement under 97(c).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.

Customer Number 21186

Atty: Marvin L. Beekman

Reg. No. 38,377

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this ______ day of November, 2007.

Name

Signature

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.

(GENERAL)